1. Description

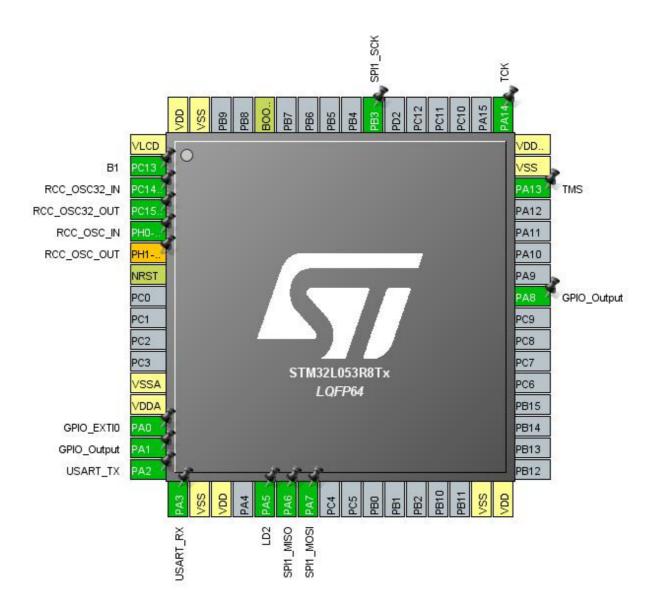
1.1. Project

Project Name	SensorDemo_BLESensor-App
Board Name	NUCLEO-L053R8
Generated with:	STM32CubeMX 5.0.0
Date	12/29/2018

1.2. MCU

MCU Series	STM32L0
MCU Line	STM32L0x3
MCU name	STM32L053R8Tx
MCU Package	LQFP64
MCU Pin number	64

2. Pinout Configuration



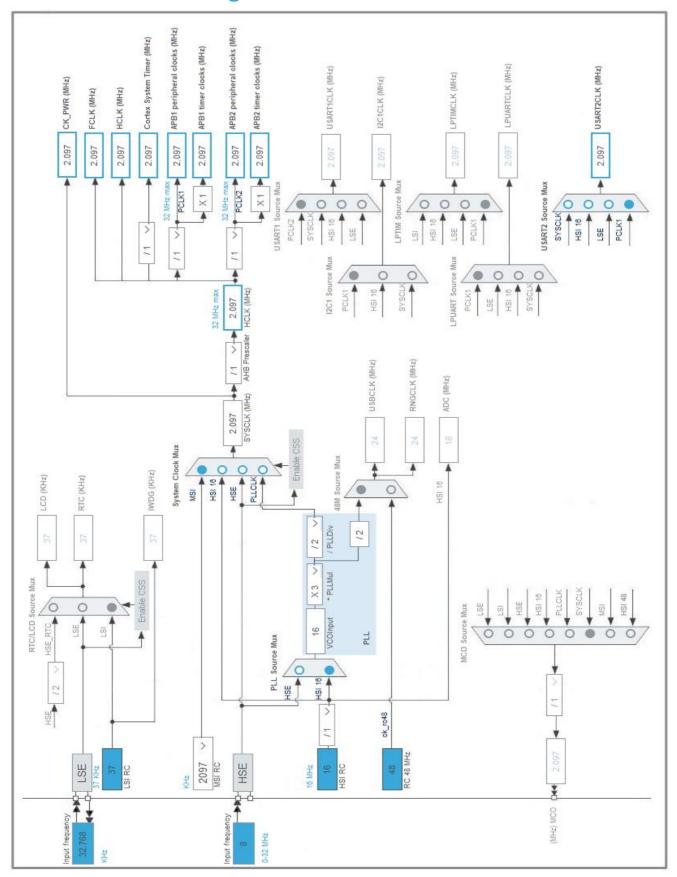
3. Pins Configuration

Pin Number LQFP64	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VLCD	Power		
2	PC13	I/O	GPIO_EXTI13	B1
3	PC14-OSC32_IN	I/O	RCC_OSC32_IN	
4	PC15-OSC32_OUT	I/O	RCC_OSC32_OUT	
5	PH0-OSC_IN	I/O	RCC_OSC_IN	
6	PH1-OSC_OUT *	I/O	RCC_OSC_OUT	
7	NRST	Reset		
12	VSSA	Power		
13	VDDA	Power		
14	PA0	I/O	GPIO_EXTI0	
15	PA1 **	I/O	GPIO_Output	
16	PA2	I/O	USART2_TX	USART_TX
17	PA3	I/O	USART2_RX	USART_RX
18	VSS	Power		
19	VDD	Power		
21	PA5 **	I/O	GPIO_Output	LD2
22	PA6	I/O	SPI1_MISO	
23	PA7	I/O	SPI1_MOSI	
31	VSS	Power		
32	VDD	Power		
41	PA8 **	I/O	GPIO_Output	
46	PA13	I/O	SYS_SWDIO	TMS
47	VSS	Power		
48	VDD_USB	Power		
49	PA14	I/O	SYS_SWCLK	TCK
55	PB3	I/O	SPI1_SCK	
60	воото	Boot		
63	VSS	Power		
64	VDD	Power		

^{**} The pin is affected with an I/O function

^{*} The pin is affected with a peripheral function but no peripheral mode is activated

4. Clock Tree Configuration



5. Software Project

5.1. Project Settings

Name	Value		
Project Name	SensorDemo_BLESensor-App		
Project Folder	C:\Users\TobXtreme\Desktop\From0STM32		
Toolchain / IDE	EWARM V7		
Firmware Package Name and Version	STM32Cube FW_L0 V1.11.0		

5.2. Code Generation Settings

Name	Value
STM32Cube Firmware Library Package	Add necessary library files as reference in the toolchain project configuration file
Generate peripheral initialization as a pair of '.c/.h' files	No
Backup previously generated files when re-generating	No
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power	No
consumption)	

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32L0
Line	STM32L0x3
мси	STM32L053R8Tx
Datasheet	025844 Rev7

6.2. Parameter Selection

Temperature	25
17/(10)	null

7. IPs and Middleware Configuration 7.1. RCC

High Speed Clock (HSE): BYPASS Clock Source Low Speed Clock (LSE): Crystal/Ceramic Resonator

7.1.1. Parameter Settings:

System Parameters:

VDD voltage (V) 3.3

Buffer Cache Enabled

Prefetch Disabled

Preread Enabled

Flash Latency(WS) 0 WS (1 CPU cycle)

RCC Parameters:

HSI Calibration Value 16

MSI Calibration Value 0

HSE Startup Timout Value (ms) 100

LSE Startup Timout Value (ms) 5000

Power Parameters:

Power Regulator Voltage Scale Power Regulator Voltage Scale 1

7.2. SPI1

Mode: Full-Duplex Master 7.2.1. Parameter Settings:

Basic Parameters:

Frame Format Motorola

Data Size 8 Bits

First Bit MSB First

Clock Parameters:

Prescaler (for Baud Rate) 2

Baud Rate 1.0485 MBits/s *

Clock Polarity (CPOL) Low
Clock Phase (CPHA) 1 Edge

Advanced Parameters:

CRC Calculation Disabled
NSS Signal Type Software

7.3. SYS

mode: Debug Serial Wire Timebase Source: SysTick

7.4. **USART2**

Mode: Asynchronous

7.4.1. Parameter Settings:

Basic Parameters:

Baud Rate 115200

Word Length 8 Bits (including Parity)

Parity None Stop Bits 1

Advanced Parameters:

Data Direction Receive and Transmit

Over Sampling 16 Samples
Single Sample Disable

Advanced Features:

Auto Baudrate Disable TX Pin Active Level Inversion Disable **RX Pin Active Level Inversion** Disable Data Inversion Disable TX and RX Pins Swapping Disable Enable Overrun DMA on RX Error Enable MSB First Disable

7.5. STMicroelectronics.X-CUBE-BLE1.4.2.0

mode: WirelessJjBlueNRGAaMS mode: WirelessJjApplication 7.5.1. Parameter Settings:

Log & Debug:

DEBUG No debug message (0)

PRINT_CSV_FORMAT CSV format message print disabled (0)

HCI Basic Parameters:

HCI_READ_PACKET_SIZE

128 Bytes reserved for HCI Read Packet

HCI_MAX_PAYLOAD_SIZE

128 Bytes reserved for HCI Max Payload

Connection Parameters (for expert users):

 Scan Interval (SCAN_P)
 16384

 Scan Window (SCAN_L)
 16384

 Supervision Timeout (SUPERV_TIMEOUT)
 60

 Min Connection Period (CONN_P1)
 40

 Max Connection Period (CONN_P2)
 40

 Min Connection Length (CONN_L1)
 2000

 Max Connection Length (CONN_L2)
 2000

Advertising Type (ADV_DATA_TYPE)

Connectable Undirected Advertising

(ADV_IND)

Min Advertising Interval (ADV_INTERV_MIN)2048Max Advertising Interval (ADV_INTERV_MAX)4096Min Connection Event Interval (L2CAP_INTERV_MIN)9Max Connection Event Interval (L2CAP_INTERV_MAX)20Timeout Multiplier (L2CAP_TIMEOUT_MULTIPLIER)600

^{*} User modified value

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PC14- OSC32_IN	RCC_OSC32_IN	n/a	n/a	n/a	
	PC15- OSC32_OU T	RCC_OSC32_O UT	n/a	n/a	n/a	
	PH0- OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
SPI1	PA6	SPI1_MISO	Alternate Function Push Pull	No pull-up and no pull-down	Very High	
	PA7	SPI1_MOSI	Alternate Function Push Pull	No pull-up and no pull-down	Very High	
	PB3	SPI1_SCK	Alternate Function Push Pull	No pull-up and no pull-down	Very High	
SYS	PA13	SYS_SWDIO	n/a	n/a	n/a	TMS
	PA14	SYS_SWCLK	n/a	n/a	n/a	TCK
USART2	PA2	USART2_TX	Alternate Function Push Pull	No pull-up and no pull-down	Low	USART_TX
	PA3	USART2_RX	Alternate Function Push Pull	No pull-up and no pull-down	Low	USART_RX
Single Mapped Signals	PH1- OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
GPIO	PC13	GPIO_EXTI13	External Interrupt Mode with Falling edge trigger detection	No pull-up and no pull-down	n/a	B1
	PA0	GPIO_EXTI0	External Interrupt Mode with Rising edge trigger detection	No pull-up and no pull-down	n/a	
	PA1	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	
	PA5	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	LD2
	PA8	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	

8.2. DMA configuration

nothing configured in DMA service

8.3. NVIC configuration

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable interrupt	true	0	0
Hard fault interrupt	true	0	0
System service call via SWI instruction	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
EXTI line 0 and line 1 interrupts	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash and EEPROM global interrupt	unused		
RCC and CRS global interrupt	unused		
EXTI line 4 to 15 interrupts	unused		
SPI1 global interrupt	unused		
USART2 global interrupt / USART2 wake-up interrupt through EXTI line 26	unused		

^{*} User modified value

9. Software Pack Report

9.1. Software Pack selected

Vendor	Name	Version	Component
STMicroelectronic	X-CUBE-BLE1	4.2.0	Class : Wireless
s			Group : Controller
			Version: 0.0.2
			Class : Wireless
			Group : HCI_TL
			Variant : Basic
			Version: 0.0.2
			Class : Wireless
			Group :
			HCI_TL_INTERF
			ACE
			Variant :
			UserBoard
			Version: 0.0.2
			Class : Wireless
			Group : Utils
			Version: 0.0.2
			Class : Wireless
			Group :
			Application
			Variant :
			SensorDemoBLE
			Sensor
			Version: 0.0.2